LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司



WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER :				
MODULE NO.:	WG12864A-TMI-V#N			
APPROVED BY:				
(FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:		

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
Н	2021/01/05		Add Interface



MODLE NO:

華凌光電股份有限公司

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUI	MMARY
0	2011/01/24		irst issue	
A	2013/06/04		emove IC	information
В	2013/07/05		lodify scre	w hole
С	2016/01/27		lodify Pred	autions in use
			LCD Mod	dules
			& Static el	ectricity test
D	2016/03/31		Iodify Res	ponse Time
Е	2017/02/15		lodify Bac	klight
			formation	
F	2019/08/27		lodify Mat	erial List of
			omponents	s for RoHs
G	2019/12/17		lodify Pred	cautions in use
			LCD Mod	dules
Н	2021/01/05		dd Interfac	ce

Contents

- 1. Module Classification Information
- 2.Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
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- 10.Backlight Information
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1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 128 * 64 dot

Model serials no.

 \bigcirc Backlight Type: N \rightarrow Without backlight T \rightarrow LED, White L \rightarrow LED, Full color

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow$ EL, Yellow Green $G\rightarrow$ LED, Green $H\rightarrow$ DIP LED, Amber $F\rightarrow$ CCFL, White $P\rightarrow$ LED, Blue $I\rightarrow$ DIP LED, Red

 $Y \rightarrow LED$, Yellow Green $X \rightarrow LED$, Dual color $G \rightarrow LED$, Green $C \rightarrow LED$, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00 direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00 L→Transmissive, W.T, 6:00 L→Transmissive, W.T, 6:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V : Build in Negative Voltage

#:Fit in with the ROHS Directions and regulations

N: IC NT7107,NT7108

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

3.General Specification

Item	Dimension	Unit					
Number of dots	128 x 64	_					
Module dimension	93.0 x 70.0 x 13.6 (MAX)	mm					
View area	72.0 x 40.0	mm					
Active area	66.52 x 33.24	mm					
Dot size	0.48 x 0.48	mm					
Dot pitch	0.52 x 0.52	mm					
LCD type	STN Negative, Blue Transmissive (In LCD production, It will occur slightly color can only guarantee the same color in the same b	(In LCD production, It will occur slightly color difference. We					
Duty	1/64						
View direction	6 o'clock	6 o'clock					
Backlight Type	LED, White	LED, White					
IC	NT7107, NT7108	NT7107, NT7108					
Interface	68 series	68 series					

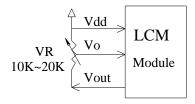
4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}\! \mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Supply Voltage For Logic	V _{DD} -V _{SS}	-0.3		7.0	V
Driver Supply Voltage	V_{LCD}	V _{EE} -0.3	_	V _{DD} +0.3	V

5.Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
Supply Voltage For		Ta=-20°C	_	_	10.6	V
LCD	V_{DD} - V_{O}	Ta=25°℃	8.6	8.9	9.2	V
*Note		Ta=70°C	7.6	—	_	V
Input High Volt.	V_{IH}	_	$0.7~\mathrm{V_{DD}}$	_	V_{DD}	V
Input Low Volt.	V_{IL}	_	0	_	0.8	V
Output High Volt.	V_{OH}	_	2.4	_	_	V
Output Low Volt.	V_{OL}			_	0.4	V
Supply Current	I_{DD}	V _{DD} =5.0V	_	29.2	_	mA

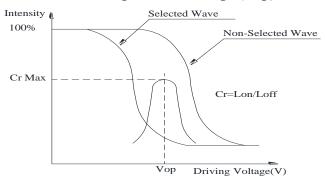
^{*} Note: Please design the VOP adjustment circuit on customer's main board



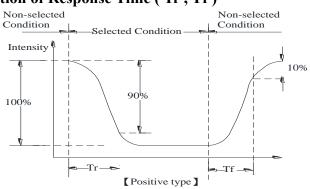
6.Optical Characteristics

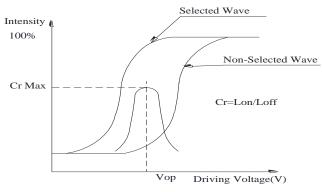
Item	Symbol	Condition	Min	Тур	Max	Unit
	heta	CR≧2	0	_	20	$\phi = 180^{\circ}$
V A1 -	θ	CR≧2	0	_	40	$\phi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	30	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
D T'	T rise	_	_	200	300	ms
Response Time	T fall	_	_	250	30 30 —	ms

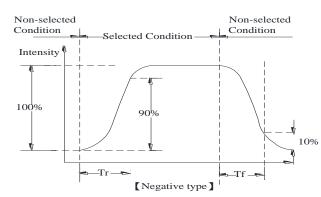
Definition of Operation Voltage (Vop)



Definition of Response Time (Tr, Tf)





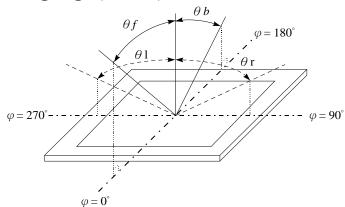


Conditions:

Operating Voltage: Vop Frame Frequency: 64 HZ Viewing Angle(θ , φ): 0° , 0°

Z Driving Waveform: 1/N duty, 1/a bias

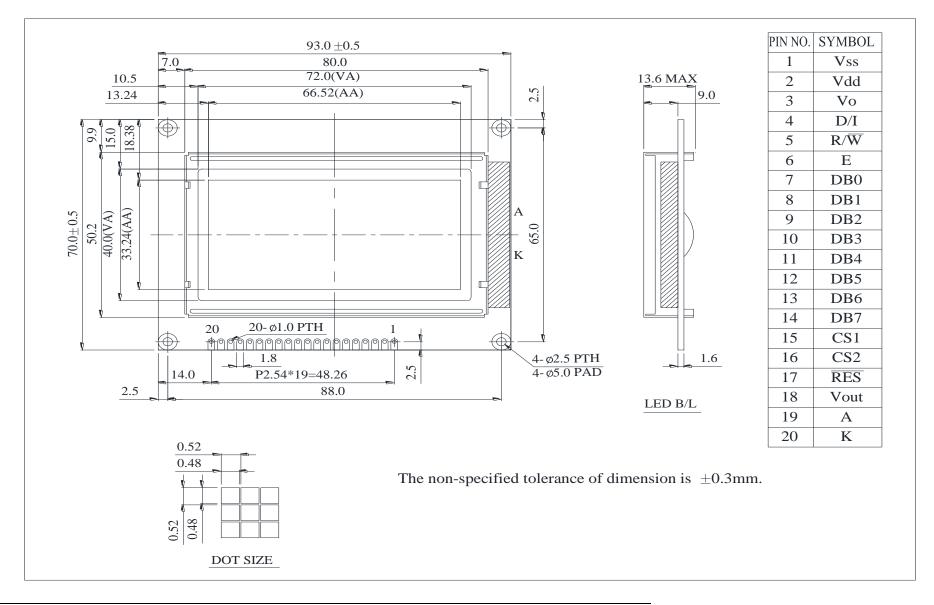
Definition of viewing angle(CR≥2)

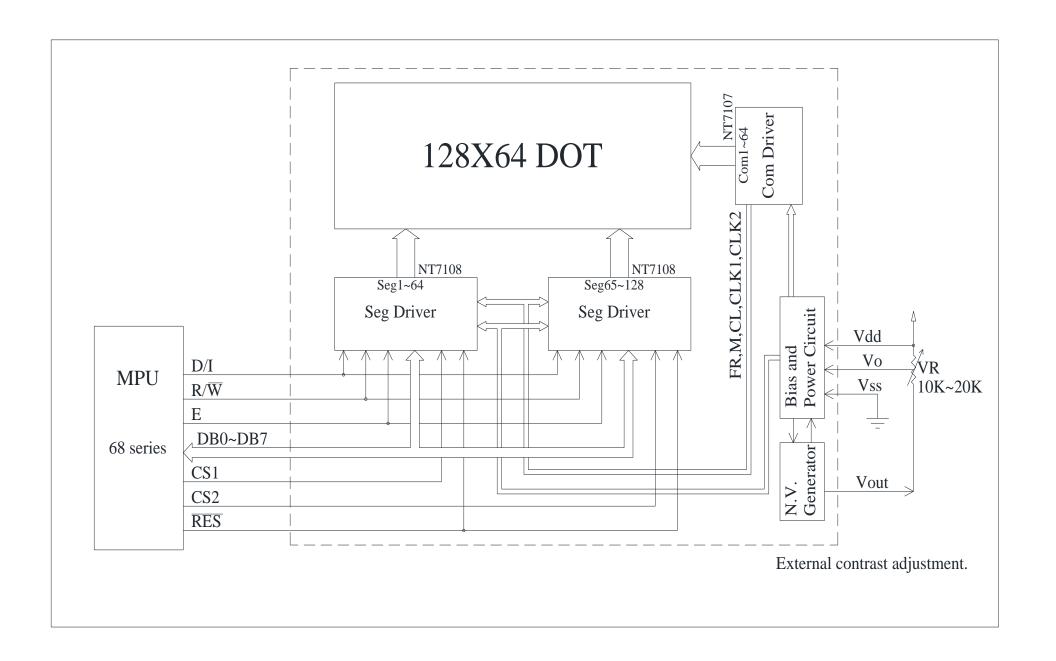


7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	V _{SS}	0V	Ground
2	V_{DD}	5.0V	Supply voltage for logic
3	Vo	(Variable)	Operating voltage for LCD
4	D/I	H/L	H: Data, L: Instruction
5	R/W	H/L	H: Read (MPU←Module) , L: Write (MPU→Module)
6	Е	Н	Enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	CS1	Н	Select Column 1~ Column 64
16	CS2	Н	Select Column 65~ Column 128
17	/RES	L	Reset signal
18	Vout		Negative Voltage output
19	A	_	Power Supply for LED backlight (+)
20	K	_	Power Supply for LED backlight (-)

8.Contour Drawing & Block Diagram





9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test						
Test Item	Content of Test	Test Condition	Not e			
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2			
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2			
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	_			
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1			
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2			
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles				
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times				

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

Specification

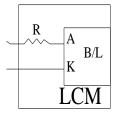
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	20	64	80	mA	V=3.5V(Note 1)
Supply Voltage	V	3.4	3.5	3.6	V	_
Reverse Voltage	VR	_	_	5	V	_
Luminance (Without LCD)	IV	440	550	_	CD/M ²	ILED=64mA
LED Life Time (For Reference only)	_	_	50K	_	Hr.	ILED=64mA 25°C,50-60%RH, (Note 2)
Color	White		•	1		

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1: Supply current minimum value is only for reference since LED brightness efficiency keeps enhancing. Current consumption becomes less and less to achieve the same luminance.

Note 2:50K hours is only an estimate for reference.

.Drive from pin19,pin20



11.Inspection specification

No	Item			Criterion		AQL			
		Missing vertical,	, horizont	al segment, segment	contrast defect.				
		Missing characte	er, dot or	icon.					
		Display malfunc	Display malfunction.						
01	Electrical	No function or n	o display.			0.65			
01	Testing	Current consump	otion exce	eeds product specific	cations.	0.03			
		LCD viewing an	gle defec	t.					
		Mixed product ty	ypes.						
		Contrast defect.							
	Black or white	2.1 White and bl	ack spots	on display $\leq 0.25 \text{m}$	nm, no more than				
02	spots on LCD	three white or bl	2.5						
	(display only)	2.2 Densely space	.2 Densely spaced: No more than two spots or lines within 3mm						
		3.1 Round type : As following drawing							
		$\Phi = (x + y) / 2$							
		X	ı [Size	Acceptable QTY				
			V V	Φ≦0.10	Accept no dense	2.5			
			¥ Î	$0.10 < \Phi \le 0.20$	2				
	LCD black spots,	•	3 ■ 05	$0.20 < \Phi \leq 0.25$	1				
03	white spots, contamination			$0.25 < \Phi$	0				
	(non-display)	3.2 Line type : (A	As follow	ing drawing)					
			Length	Width	Acceptable Q TY				
		~ ∕¥ w		W≦0.02	Accept no dense	2.5			
		→ L +	L≦3.0	$0.02 < W \le 0.03$	2	2.5			
			L≦2.5	$0.03 < W \le 0.05$	2				
				0.05 < W	As round type				
		If bubbles are vi	sible,	Size Φ	Acceptable Q TY				
		judge using black spot		$\Phi \leq 0.20$	Accept no dense				
04	Polarizer bubbles	specifications, no	ot easy	$0.20 < \Phi \leq 0.50$	3	2.5			
		to find, must che	eck in	$0.50 < \Phi \le 1.00$	2				
		specify direction	١.	1.00 < Φ	0				
				Total Q TY	3				

No	Item	Criterion					
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination					
06	Chipped glass	k: Seal width t: L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surf z: Chip thickness $Z \le 1/2t$ $1/2t < z \le 2t$	Glass thickness a: LC:	$x: Chip length$ $x \le 1/8a$ $x \le 1/8a$	2.5		
		z: Chip thickness	y: Chip width	x: Chip length			
		Z≦1/2t	Not over viewing area	x ≤ 1/8a			
		$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a			
		⊙ If there are 2 or more chips, x is the total length of each chip.					

No	Item	Criterion A					
No 06	Glass	remain and be inspe	y: Chip width t: Glass thicknown terminal: rode pad: x: Chip x ≤ 1 ve portion: x: Chip x ≤ 1 a touches the ITC exted according to the least sealed be a se	z: Chipess a: LCI L Z length /8a length /8a terminal, of electrode to y the custon		2.5 must ns. nark not	

No	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	
		8.1 Illumination source flickers when lit.	
0.0	Backlight	8.2 Spots or scratched that appear when lit must be judged. Using	
08	elements	LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5
		contamination.	
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the seal	2.5
		area on the PCB. And there should be no more than three places.	
		10.5 No oxidation or contamination PCB terminals.	
		10.6 Parts on PCB must be the same as on the production	2.5
10	PCB · COB	characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product	0.65
		characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5
		10.9 The Scraping testing standard for Copper Coating of PCB	2.3
		10.9 The Scraping testing standard for copper Coating of I CB	2.5
		X	2.3
		\mathbf{Y} $\mathbf{X} * \mathbf{Y} \leq 2\mathbf{m}\mathbf{m}^2$	
		11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections, oxidation	2.5
11	Soldering	or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion			
		12.1 No oxidation, contamination, curves or, bends on interface Pin	2.5		
		(OLB) of TCP.			
		12.2 No cracks on interface pin (OLB) of TCP.	0.65		
		12.3 No contamination, solder residue or solder balls on product.	2.5		
		12.4 The IC on the TCP may not be damaged, circuits.	2.5		
		12.5 The uppermost edge of the protective strip on the interface pin	2.5		
		must be present or look as if it cause the interface pin to sever.			
	General appearance	12.6 The residual rosin or tin oil of soldering (component or chip	2.5		
12		component) is not burned into brown or black color.			
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5		
		12.8 Pin type must match type in specification sheet.	0.65		
		12.9 LCD pin loose or missing pins.	0.65		
		12.10 Product packaging must the same as specified on packaging	0.65		
		specification sheet.			
		12.11 Product dimension and structure must conform to product	0.65		
		specification sheet.			
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65		

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limited value is set up according to RoHS.										

2. Process for RoHS requirement : (only for RoHS inspection)

(1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.

(2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

		Feedback Sheet
dule Number:		Page: 1
1 · Panel Specification:		
1. Panel Type:	Pass	□ NG ,
2. View Direction:	Pass	□ NG ,
3. Numbers of Dots:	Pass	□ NG ,
4. View Area:	Pass	□ NG ,
5. Active Area:	Pass	□ NG ,
6. Operating Temperature:	Pass	□ NG ,
7. Storage Temperature:	Pass	□ NG ,
8. Others:		
2 · Mechanical Specification :		
1. PCB Size:	Pass	□ NG ,
2. Frame Size:	Pass	□ NG ,
3. Materal of Frame:	Pass	□ NG ,
4. Connector Position:	Pass	□ NG ,
5. Fix Hole Position:	Pass	□ NG ,
6. Backlight Position:	Pass	□ NG ,
7. Thickness of PCB:	Pass	□ NG ,
8. Height of Frame to PCB:	Pass	□ NG ,
9. Height of Module:	Pass	□ NG ,
10. Others:	☐ Pass	□ NG ,
3 · <u>Relative Hole Size</u> :		
1. Pitch of Connector:	Pass	□ NG ,
2. Hole size of Connector:	Pass	□ NG ,
3. Mounting Hole size:	Pass	□ NG ,
4. Mounting Hole Type:	Pass	□ NG ,
5. Others:	Pass	□ NG ,
4 · <u>Backlight Specification</u> :		
1. B/L Type:	Pass	☐ NG ,
2. B/L Color:	Pass	☐ NG ,
3. B/L Driving Voltage (Refere	nce for LED	Type): Pass NG,
4. B/L Driving Current:	Pass	□ NG,
5. Brightness of B/L:	Pass	□ NG ,
6. B/L Solder Method:	Pass	□ NG ,
7. Others:	☐ Pass	☐ NG ,

	winstar		
Modu	le Number:		Page: 2
5 、	Electronic Characteristics of		
1.	Input Voltage:	☐ Pass	□ NG ,
2.	Supply Current:	☐ Pass	□ NG ,
3.	Driving Voltage for LCD:	☐ Pass	□ NG ,
4.	Contrast for LCD:	Pass	□ NG ,
5.	B/L Driving Method:	Pass	☐ NG ,
6.	Negative Voltage Output:	Pass	☐ NG ,
7.	Interface Function:	☐ Pass	☐ NG ,
8.	LCD Uniformity:	☐ Pass	□ NG ,
9.	ESD test:	☐ Pass	□ NG ,
10.	Others:	☐ Pass	□ NG ,
6、	Summary :		
	Sales signature:		
	Customer Signature:		Date : / /